Triacs

Silicon Bidirectional Thyristors

Designed primarily for full wave ac control applications, such as motor controls, heating controls or dimmers; or wherever full-wave, silicon gate-controlled devices are needed.

Features

- High Commutating di/dt and High Immunity to dV/dt @ 125°C
- Minimizes Snubber Networks for Protection
- Blocking Voltage to 800 Volts
- On-State Current Rating of 16 Amperes RMS
- High Surge Current Capability 150 Amperes
- Industry Standard TO-220 Package for Ease of Design
- Glass Passivated Junctions for Reliability and Uniformity
- Operational in Three Quadrants, Q1, Q2, and Q3
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
$\begin{array}{l} \mbox{Peak Repetitive Off-State Voltage (Note 1)} \\ (T_J = -40 \mbox{ to } 125^\circ\mbox{C}) & MAC16\mbox{CM} \\ MAC16\mbox{CN} \end{array}$	V _{DRM,} V _{RRM}	600 800	V
On-State RMS Current (Full Cycle Sine Wave 50 to 60 Hz; $T_{C} = 80^{\circ}C$)	I _{T(RMS)}	16	A
Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, $T_J = 125^{\circ}C$)	I _{TSM}	150	A
Circuit Fusing Consideration (t = 8.33 ms)	l ² t	93	A ² sec
Peak Gate Power (Pulse Width \leq 1.0 μ s, T _C = 80°C)	P _{GM}	20	W
Average Gate Power (t = 8.3 ms, $T_C = 80^{\circ}C$)	P _{G(AV)}	0.5	W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

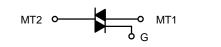
1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

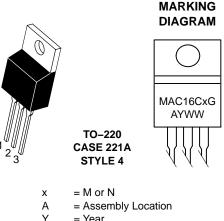


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TRIACS **16 AMPERES RMS** 400 thru 800 VOLTS





= Year

ww = Work Week

= Pb-Free Package G

	PIN ASSIGNMENT
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

ORDERING INFORMATION

Device	Package	Shipping
MAC16CMG	TO–220 (Pb–Free)	50 Units / Rail
MAC16CNG	TO-220 (Pb-Free)	50 Units / Rail

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	ΤL	260	°C

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted; Electricals apply in both directions)

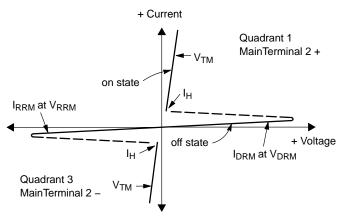
Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Blocking Current (V _D = Rated V _{DRM} , V _{RRM} Gate Open)	T _J = 25°C T _J = 125°C	I _{DRM,} I _{RRM}			0.01 2.0	mA
ON CHARACTERISTICS			•	•	•	
Peak On-State Voltage (Note 2) ($I_{TM} = \pm 21 \text{ A Peak}$)		V _{TM}	-	1.2	1.6	V
Gate Trigger Current (Continuous DC) $(V_D = 12 V, R_L = 100 \Omega)$ MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)		I _{GT}	8.0 8.0 8.0	12 16 20	35 35 35	mA
Holding Current ($V_D = 12 V$, Gate Open, Initiating Current = $\pm 150 \text{ mA}$)		Ι _Η	_	20	50	mA
Latching Current (V _D = 12 V, I_G = 35 mA) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)		ι		25 40 24	50 80 50	mA
Gate Trigger Voltage (Continuous DC) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega)$ MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)		V _{GT}	0.5 0.5 0.5	0.75 0.72 0.82	1.5 1.5 1.5	V
DYNAMIC CHARACTERISTICS		+	4		4	
Rate of Change of Commutating Current ($V_D = 400 \text{ V}, I_{TM} = 6.0 \text{ A}, \text{ Commutating dV/dt} = 24 \text{ V/}\mu\text{s}, \text{ Gate Open}$ $T_J = 125^{\circ}\text{C}, f = 250 \text{ Hz}, C_L = 10 \mu\text{F}, L_L = 40 \text{ mH}, \text{ with Snubber})$		(di/dt) _c	15	-	-	A/ms
Critical Rate of Rise of Off-State Voltage		dV/dt	600	_	_	V/us

$(V_D = Rated V_{DRM}, Exponential Waveform, Gate Open, T_J = 125°C)$	uviu	000		_	ν/μ5	
Repetitive Critical Rate of Rise of On-State Current IPK = 50 A; PW = 40 μsec; diG/dt = 200 mA/μsec; f = 60 Hz	di/dt	-	-	10	A/μs	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 2. Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

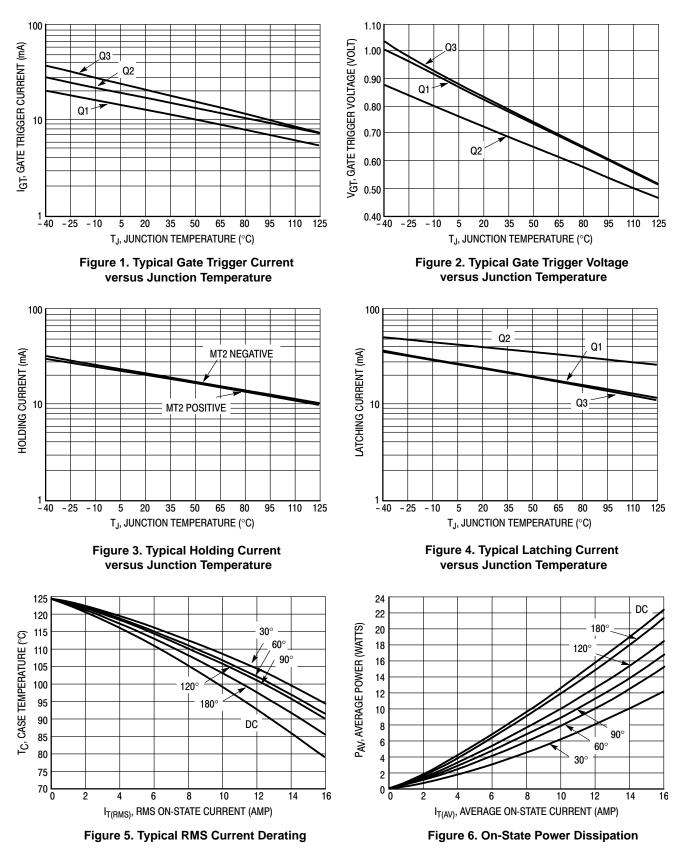


MT2 POSITIVE (Positive Half Cycle) + (+) MT2 (+) MT2 Quadrant II (+) I_{GT} Quadrant I (–) I_{GT} 0 o **ф** МТ1 **ф** МТ1 --REF REF I_{GT} + I_{GT} (–) MT2 (-) MT2 Quadrant III (+) I_{GT} GATE **Quadrant IV** (–) I_{GT} GATE 0 0 MT1 **ф** МТ1 Ξ Ξ REF REF MT2 NEGATIVE (Negative Half Cycle)

Quadrant Definitions for a Triac

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.



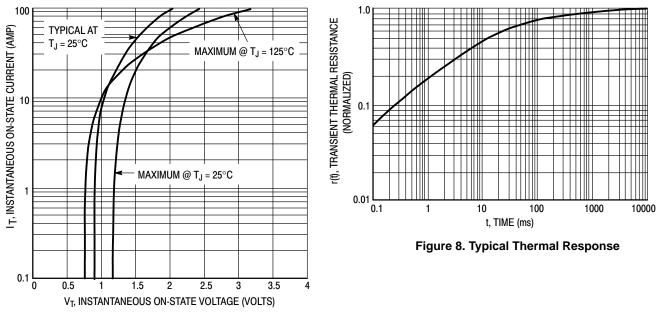
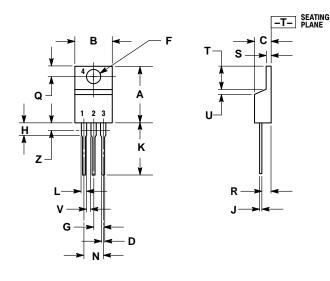


Figure 7. On-State Characteristics

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH**



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

2.

3 DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
Κ	0.500	0.562	12.70	14.27
Г	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Z		0.080		2.04

STYLE 4: PIN 1. MAIN TERMINAL 1 MAIN TERMINAL 2 2. 3. GATE MAIN TERMINAL 2 Λ

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